Preferred Device

## High Voltage Switching Diode

• Device Marking: JR



### ON Semiconductor®

http://onsemi.com

### HIGH VOLTAGE SWITCHING DIODE

1 O 2 CATHODE ANODE



SOD-323 CASE 477 STYLE 1

### MARKING DIAGRAM



JR = Specific Device Code M = Date Code

### **ORDERING INFORMATION**

Device	Package	Shipping†
BAS20HT1	SOD-323	3000/Tape & Reel

<sup>+</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

**Preferred** devices are recommended choices for future use and best overall value.

### MAXIMUM RATINGS

Symbol	Rating		Unit
V <sub>R</sub>	Continuous Reverse Voltage	200	Vdc
V <sub>RRM</sub>	Repetitive Peak Reverse Voltage	200	Vdc
١ <sub>F</sub>	Peak Forward Current	200	mAdc
I <sub>FM(surge)</sub>	Peak Forward Surge Current	625	mAdc

### THERMAL CHARACTERISTICS

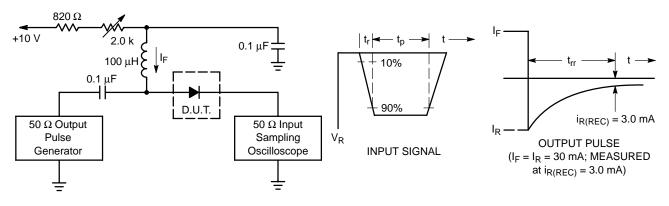
Symbol	Characteristic	Max	Unit
PD	Total Device Dissipation FR–5 Board,* $T_A = 25^{\circ}C$	200	mW
	Derate above 25°C	1.57	mW/°C
$R_{\thetaJA}$	Thermal Resistance Junction to Ambient	635	°C/W
T <sub>J</sub> , T <sub>stg</sub>	Junction and Storage Temperature Range	–55 to +150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

\*FR-5 Minimum Pad

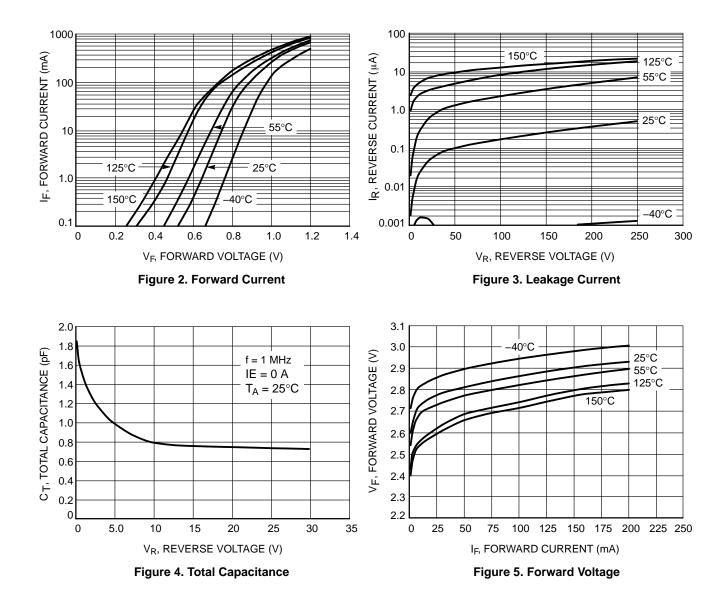
### **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Reverse Voltage Leakage Current $(V_R = 200 \text{ Vdc})$ $(V_R = 200 \text{ Vdc}, T_J = 150^{\circ}\text{C})$	I <sub>R</sub>		1.0 100	μAdc
Reverse Breakdown Voltage (I <sub>BR</sub> = 100 μAdc)	V <sub>(BR)</sub>	250	-	Vdc
Forward Voltage (I <sub>F</sub> = 100 mAdc) (I <sub>F</sub> = 200 mAdc)	V <sub>F</sub>		1000 1250	mV
Diode Capacitance (V <sub>R</sub> = 0, f = 1.0 MHz)	C <sub>D</sub>	-	5.0	pF
Reverse Recovery Time $(I_F = I_R = 30 \text{ mAdc}, R_L = 100 \Omega)$	t <sub>rr</sub>	-	50	ns



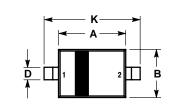
Notes: 1. A 2.0 k $\Omega$  variable resistor adjusted for a Forward Current (I<sub>F</sub>) of 30 mA. 2. Input pulse is adjusted so I<sub>R(peak)</sub> is equal to 30 mA. 3. t<sub>p</sub> » t<sub>rr</sub>

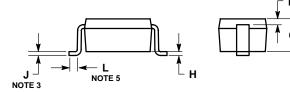




### PACKAGE DIMENSIONS

**SOD-323** CASE 477-02 ISSUE D





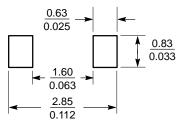
NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: MILLIMETERS.
   LEAD THICKNESS SPECIFIED PER L/F DRAWING WITH SOLDER PLATING.
- DRAWING WITH SOLDER PLATING.
  4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE
- MOLD FLASH, PROTRUSIONS OR GATE BURRS. DIMENSION L IS MEASURED FROM END OF
- DIMENSION L IS MEASURED FROM END OF RADIUS.

	MILLIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	1.60	1.80	0.063	0.071	
В	1.15	1.35	0.045	0.053	
С	0.80	1.00	0.031	0.039	
D	0.25	0.40	0.010	0.016	
E	0.15 REF		0.006 REF		
н	0.00	0.10	0.000	0.004	
J	0.089	0.177	0.0035	0.0070	
K	2.30	2.70	0.091	0.106	
L	0.075		0.003		

STYLE 1: PIN 1. CATHODE 2. ANODE

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